| Electronic Patent Application Fee Transmittal | | | | | | | |
|---|----------|---|----------|--------|----------------------|--|--|
| Application Number: | 10 | 10739456 | | | | | |
| Filing Date: | 17 | 17-Dec-2003 | | | | | |
| Title of Invention: | Te pa | Tape circuit substrate having wavy beam leads and semiconductor chip package using the same | | | | | |
| First Named Inventor: | Da | Dae-Woo Son | | | | | |
| Filer: | Al | Alexander Charles Johnson/Li mei Vermilya | | | | | |
| Attorney Docket Number: | 99 | 9903-068 | | | | | |
| Filed as Large Entity | | | | | | | |
| Utility Filing Fees | | | | | | | |
| Description | | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | |
| Basic Filing: | | | | | 1 | | |
| Pages: | ۰ | | | | | | |
| Claims: | | | | | | | |
| Independent claims in excess of 3 | | 1201 | 1 | 200 | 200 | | |
| Miscellaneous-Filing: | | | | | | | |
| Petition: | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | |
| Extension-of-Time: | | | | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-----------------------------------|----------|----------|--------|-------------------------|
| Extension - 1 month with \$0 paid | 1251 | 1 | 120 | 120 |
| Miscellaneous: | | | | |
| Request for continued examination | 1801 | 1 | 790 | 790 |
| | Tota |) (\$) | 1110 | |